

Amendments to the Specification:

On page 1, prior to the first paragraph which begins on line 3, please insert the following:

FIELD OF THE INVENTION

Please replace the paragraph which begins on page 1, line 3 and which ends on page 1, line 9, with the following rewritten paragraph:

The invention relates to a method for populating and soldering a circuit board, to a reflow oven for soldering the circuit board and to a circuit board for ~~said~~ the method. Especially, the invention relates to such circuit boards, which are populated with a wired electrical component having at least one connection wire or pin and a housing or casing thermally critical for conventional automatic soldering processes.

On page 1, prior to the second paragraph which begins on line 10, please insert the following:

BACKGROUND OF THE INVENTION

On page 2, prior to the paragraph which begins on line 26, please insert the following:

SUMMARY OF THE INVENTION

On page 8, prior to the paragraph which begins on line 8, please insert the following:

BRIEF DESCRIPTION OF THE DRAWINGS

On page 9, prior to the paragraph which begins on line 8, please insert the following:

DESCRIPTION OF THE PREFERRED EMBODIMENTS